

1 of 2:8 Differential Clock/Data Fanout Buffer

Features

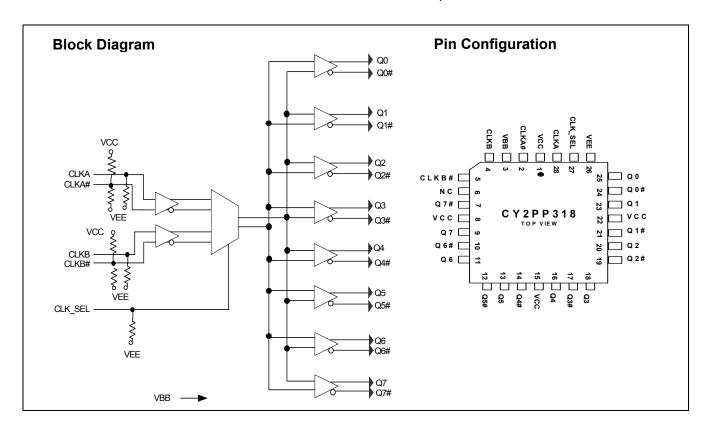
- Eight ECL/PECL differential outputs
- Two ECL/PECL differential inputs
- · Hot-swappable/-insertable
- 50 ps output-to-output skew
- 150 ps device-to-device skew
- 500 ps propagation delay (typical)
- 1.5 GHz Operation (2.2 GHz max. toggle frequency)
- 1.2 ps RMS period jitter (typ.)
- PECL mode supply range: V_{CC} = 2.5V± 5% to 3.3V±5% with V_{EE} = 0V
- ECL mode supply range: V_{E E} = -2.5V± 5% to -3.3V±5% with V_{CC} = 0V
- Industrial temperature range: -40°C to 85°C
- 28-pin PLCC package
- Temperature compensation like 100K ECL

Functional Description

The CY2PP318 is a low-skew, low propagation delay 1-to-8 differential fanout buffer targeted to meet the requirements of high-performance clock and data distribution applications. The device is implemented on SiGe technology and has a fully differential internal architecture that is optimized to achieve low signal skews at operating frequencies of up to 1.5 GHz.

The device features two differential input paths that are multiplexed internally. This mux is controlled by the CLK_SEL pin. The CY2PP318 may function not only as a differential clock buffer but also as a signal-level translator and fanout on ECL/PECL signal to eight ECL/PECL differential loads. An external bias pin, VBB, is provided for this purpose. In such an application, the VBB pin should be connected to either one of the CLKA# or CLKB# inputs and bypassed to ground via a $0.01\mbox{-}\mu\text{F}$ capacitor.

Since the CY2PP318 introduces negligible jitter to the timing budget, it is the ideal choice for distributing high frequency, high precision clocks across back-planes and boards in communication systems. Furthermore, advanced circuit design schemes, such as internal temperature compensation, ensure that the CY2PP318 delivers consistent performance over various platforms.





Pin Definitions^[1, 2, 3]

Pin	Name	I/O	Туре	Description
3	VBB	0	Bias	Reference Voltage Output
26	VEE	-PWR	Power	Negative Supply
1, 8, 15, 22	VCC	+PWR	Power	Positive Supply
28	CLKA	I, PD	ECL/PECL	ECL/PECL Differential Input Clocks
2	CLKA#	I, PD/PU	ECL/PECL	ECL/PECL Differential Input Clocks
4	CLKB	I, PD	ECL/PECL	ECL/PECL Differential Input Clocks
5	CLKB#	I, PD/PU	ECL/PECL	ECL/PECL Differential Input Clocks
27	CLK_SEL	I, PD	ECL/PECL	ECL/PECL Input Clock Select
6	NC			No Connect
25,23,20,18,16,13,11,9	Q(0:7)	0	ECL/PECL	ECL/PECL Differential Output Clocks
24,21,19,17,14,12,10,7	Q(0;7)#	0	ECL/PECL	ECL/PECL Differential Output Clocks

Table 1.

Control	Operation
CLK_SEL	
	CLKA, CLKA# input pair is active (Default condition with no connection to pin) CLKA can be driven with ECL- or PECL-compatible signals with respective power configurations
	CLKB, CLKB# input pair is active. CLKB can be driven with ECL- or PECL-compatible signals with respective power configurations

Governing Agencies

The following agencies provide specifications that apply to the CY2PP318. The agency name and relevant specification is listed below in Table 2.

Table 2.

Agency Name	Specification
JEDEC	JESD 020B (MSL) JESD 51 (Theta JA) JESD 8–2 (ECL) JESD 65–B (skew,jitter)
Mil-Spec	883E Method 1012.1 (Thermal Theta JC)

- In the I/O column, the following notation is used: I for Input, O for Output, PD for Pull-Down, PU for Pull-Up, and PWR for Power
 In the I/O column, the following notation is used: I for Input, O for Output, PD for Pull-Down, PU for Pull-Up, and PWR for Power
 In ECL mode (negative power supply mode), V_{EE} is either –3.3V or –2.5V and V_{CC} is connected to GND (0V). In PECL mode (positive power supply mode), V_{EE} is connected to GND (0V) and V_{CC} is either +3.3V or +2.5V. In both modes, the input and output levels are referenced to the most positive supply (V_{CC}) and are between V_{CC} and V_{EE}.
 V_{BB} is available for use for single-ended bias mode for |3.3V| supplies (not |2.5V|).



Absolute Maximum Ratings

Parameter	Description	Condition	Min.	Max.	Unit
V _{CC}	Positive Supply Voltage	Non-Functional	-0.3	4.6	V
V _{EE}	Negative Supply Voltage	Non-Functional	-4.6	0.3	V
T _S	Temperature, Storage	Non-Functional	-65	+150	°C
T _J	Temperature, Junction	Non-Functional		150	°C
ESD _h	ESD Protection	Human Body Model	20	000	V
M _{SL}	Moisture Sensitivity Level			3	N.A.
Gate Count	Total Number of Used Gates	Assembled Die	2	28	gates

Multiple Supplies: The Voltage on any input or I/O pin cannot exceed the power pin during power-up. Power supply sequencing is NOT required.

Operating Conditions

Parameter	Description	Condition	Min.	Max.	Unit
I _{BB}	Output Reference Current	Relative to V _{BB}		[200]	uA
LU _I	Latch Up Immunity	Functional, typical	100		mA
T _A	Temperature, Operating Ambient	Functional	-40	+85	°C
$Ø_{Jc}$	Dissipation, Junction to Case	Functional	39 ^[4]		°C/W
$Ø_{Ja}$	Dissipation, Junction to Ambient	Functional	60 ^[4]		°C/W
I _{EE}	Maximum Quiescent Supply Current	V _{EE} pin		100 ^[5]	mA
C _{IN}	Input pin capacitance			3	pF
L _{IN}	Pin Inductance			1	nH
V _{IN}	Input Voltage	Relative to V _{CC} ^[6]	-0.3	V _{CC} + 0.3	V
V _{TT}	Output Termination Voltage	Relative to V _{CC} ^[6]	V _{CC}	- 2	V
V _{OUT}	Output Voltage	Relative to V _{CC} ^[6]	-0.3	V _{CC} + 0.3	V
I _{IN}	Input Current ^[7]	$V_{IN} = V_{IL}$, or $V_{IN} = V_{IH}$		l150l	uA

PECL DC Electrical Specifications

Parameter	Description	Condition	Min.	Max.	Unit
V _{CC}	Operating Voltage	2.5V ± 5%, V _{EE} = 0.0V 3.3V ± 5%, V _{EE} = 0.0V	2.375 3.135	2.625 3.465	V V
V _{CMR}	Differential Cross Point Voltage ^[8]	Differential operation	1.2	V _{CC}	V
V _{OH}	Output High Voltage	I _{OH} = -30 mA ^[9]	V _{CC} – 1.25	V _{CC} - 0.7	V
V _{OL}	Output Low Voltage $V_{CC} = 3.3V \pm 5\%$ $V_{CC} = 2.5V \pm 5\%$	I _{OL} = -5 mA ^[9]	V _{CC} – 1.995 V _{CC} –1.995	V _{CC} – 1.5 V _{CC} – 1.3	V
V _{IH}	Input Voltage, High	Single-ended operation	V _{CC} – 1.165	V _{CC} -0.880 ^[10]	V
V _{IL}	Input Voltage, Low	Single-ended operation	V _{CC} – 1.945 ^[10]	V _{CC} – 1.625	V
$V_{BB}^{[3]}$	Output Reference Voltage	Relative to V _{CC} ^[6]	V _{CC} – 1.620	V _{CC} – 1.220	V

- 4. Theta JA EIA JEDEC 51 test board conditions (typical value); Theta JC 883E Method 1012.1
 5. Power Calculation: V_{CC} * I_{EE} +0.5 (I_{OH} + I_{OL}) (V_{OH} V_{OL}) (number of differential outputs used); I_{EE} does not include current going off chip.
 6. where V_{CC} is 3.3V±5% or 2.5V±5%
 7. Inputs have internal pull-up/pull-down or biasing resistors which affect the input current.

- 8. Refer to Figure 1
- 9. Equivalent to a termination of 50Ω to VTT. $I_{OHMIN}=(V_{OHMIN}-V_{TT})/50$; $I_{OHMAX}=(V_{OHMAX}-V_{TT})/50$; $I_{OLMIN}=(V_{OLMIN}-V_{TT})/50$; I



ECL DC Electrical Specifications

Parameter	Description	Condition	Min.	Max.	Unit
V _{EE}	Negative Power Supply	$-2.5V \pm 5\%$, $V_{CC} = 0.0V$ $-3.3V \pm 5\%$, $V_{CC} = 0.0V$	-2.625 -3.465	-2.375 -3.135	V
V_{CMR}	Differential cross point voltage ^[8]	Differential operation	V _{EE} + 1.2	0V	V
V _{OH}	Output High Voltage	I _{OH} = -30 mA ^[9]	-1.25	-0.7	V
V _{OL}	Output Low Voltage $V_{EE} = -3.3V \pm 5\%$ $V_{EE} = -2.5V \pm 5\%$	I _{OL} = -5 mA ^[9]	-1.995 -1.995	-1.5 -1.3	V
V_{IH}	Input Voltage, High	Single-ended operation	-1.165	-0.880 ^[10]	V
V_{IL}	Input Voltage, Low	Single-ended operation	-1.945 ^[10]	-1.625	V
V _{BB} [3]	Output Reference Voltage		- 1.620	- 1.220	V

AC Electrical Specifications

Parameter	Description	Condition	Min.	Max.	Unit
V _{PP}	Differential Input Voltage ^[8]	Differential operation	0.1	1.3	V
F _{CLK}	Input Frequency	50% duty cycle Standard load		1.5	GHz
T _{PD}	Propagation Delay CLKA or CLKB to Output pair	660 MHz ^[11]	400	680	ps
Vo	Output Voltage (peak-to-peak; see Figure 2)	< 1 GHz	0.375	_	V
V _{CMRO}	Output Common Voltage Range (typ.)		V _{CC} – 1.425		V
tsk ₍₀₎	Output-to-output Skew	660 MHz ^[11] , See Figure 3	_	50	ps
tsk _(PP)	Part-to-Part Output Skew	660 MHz ^[11]	_	150	ps
T _{PER}	Output Period Jitter (rms)[12]	660 MHz ^[11]	_	1.6	ps
tsk _(P)	Output Pulse Skew ^[13]	660 MHz ^[11] , See Figure 3	-	35	ps
T_R, T_F	Output Rise/Fall Time (see Figure 2)	660 MHz 50% duty cycle Differential 20% to 80%	0.08	0.3	ns

Notes:

^{11. 50%} duty cycle; standard load; differential operation
12. For 3.3V supplies. Jitter measured differentially using an Agilent 8133A Pulse Generator with an 8500A LeCroy Wavemaster Oscilloscope using at least 10,000 data points

^{13.} Output pulse skew is the absolute difference of the propagation delay times: $|t_{PLH} - t_{PHL}|$

Timing Definitions

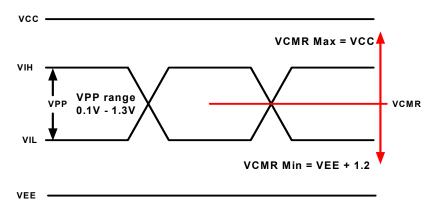


Figure 1. PECL/ECL Input Waveform Definitions

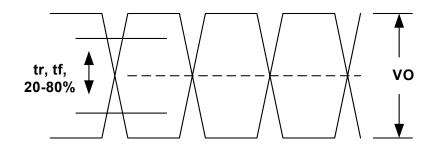


Figure 2. ECL/LVPECL Output

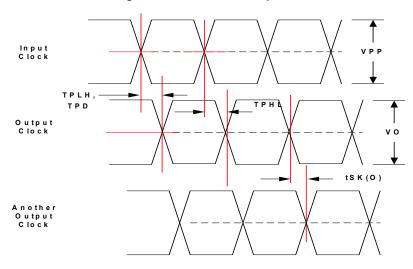


Figure 3. Propagation Delay (T_{PD}), output pulse skew ($|t_{PLH}-t_{PHL}|$), and output-to-output skew ($t_{SK(O)}$) for both CLKA or CLKB to Output Pair, PECL/ECL to PECL/ECL



Test Configuration

Standard test load using a differential pulse generator and differential measurement instrument.

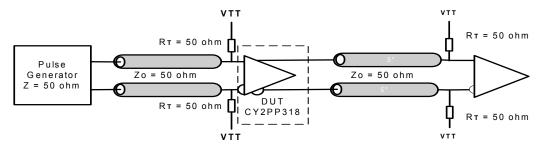


Figure 4. CY2PP318 AC Test Reference

Applications Information

Termination Examples

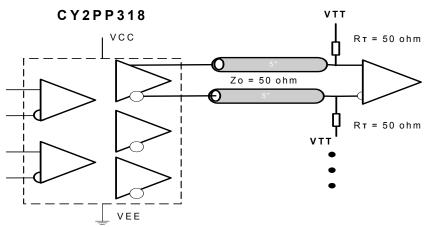


Figure 5. Standard LVPECL – PECL Output Termination

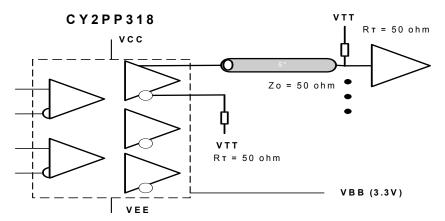


Figure 6. Driving a PECL/ECL Single-ended Input



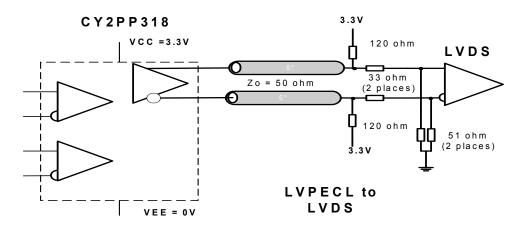


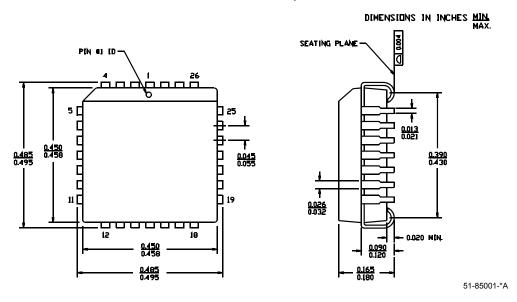
Figure 7. Low-voltage Positive Emitter-coupled Logic (LVPECL) to a Low-voltage Differential Signaling (LVDS) Interface

Ordering Information

Part Number	Package Type	Product Flow	
CY2PP318JI	28-pin PLCC	Industrial, –40° to 85°C	
CY2PP318JIT	28-pin PLCC – Tape and Reel	Industrial, –40° to 85°C	

Package Drawing and Dimensions

28-lead Plastic Leaded Chip Carrier J64



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Document History Page

Document Title: CY2PP318 FastEdge™ Series 1 of 2:8 Differential Clock/Data Fanout Buffer Document Number: 38-07501				
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	122041	02/13/03	RGL	New Data Sheet
*A	125923	06/11/03	RGL	Shifted the pin location Changed the title (ComLink to FastEdge) Corrected Specs that does not match EROS/IROS
*B	204240	See ECN	RGL	Change pin 1 from VCC to VCCO
*C	222602	See ECN	RGL	Changed the ECL and PECL mode ranges in the features section Specified tsk max value to 150ps Replaced I _{CC} calculation with power calculation in the footnote. Reformatted datasheet Revised jitter spec as period jitter (rms) Max operating frequency 1.5 GHz
*D	229352	See ECN	RGL	Added JEDEC Spec for MSL
*E	247624	See ECN	RGL/GGK	Changed V _{OH} and V _{OL} to match with the Char Data